

UF1G

**ULTRAFAST EFFICIENT
GLASS PASSIVATED RECTIFIER**
VOLTAGE: 400V CURRENT: 1.2A



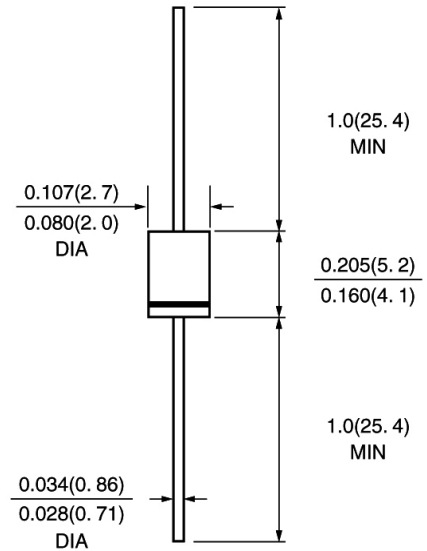
FEATURE

Low power loss
High surge capability
Glass passivated chip junction
Ultra-fast recovery time for high efficiency
High temperature soldering guaranteed
250°C/10sec/0.375" lead length at 5 lbs tension

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: Color band denotes cathode
Mounting position: Any

DO-41\DO-204AL



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	UF1G	units
Maximum Recurrent Peak Reverse Voltage	V _{rrm}	400	V
Maximum RMS Voltage	V _{rms}	280	V
Maximum DC blocking Voltage	V _{dc}	400	V
Maximum Average Forward Rectified Current 3/8" lead length at T _a =75°C	I _{f(av)}	1.2	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{fsm}	30.0	A
Maximum Forward Voltage at Forward current 1.5A Peak	V _f	1.0	V
Maximum DC Reverse Current T _a =25°C at rated DC blocking voltage T _a =125°C	I _r	10.0 50.0	μ A μ A
Maximum Reverse Recovery Time (Note 1)	T _{rr}	50	nS
Typical Junction Capacitance (Note 2)	C _j	17.0	pF
Typical Thermal Resistance (Note 3)	R(ja)	60.0	°C/W
Storage and Operating Junction Temperature	T _{stg} ,T _j	-55 to +150	°C

Note:

1. Reverse Recovery Condition I_f =0.5A, I_r =1.0A, I_{rr} =0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0V_{dc}
3. Thermal Resistance from Junction to Ambient at 3/8" lead length, P.C. Board Mounted

FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE

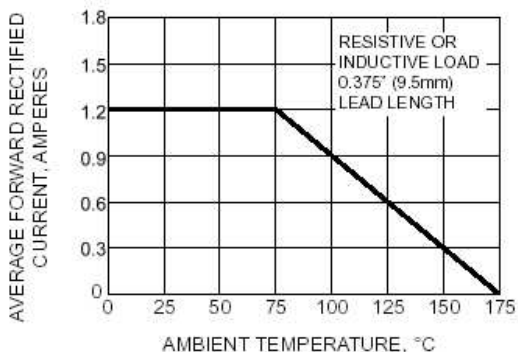


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

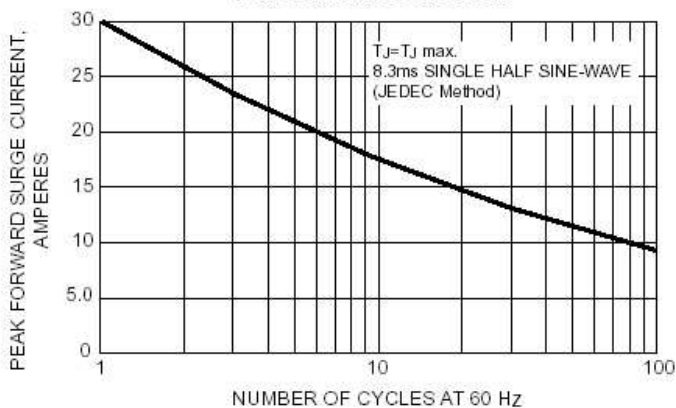


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

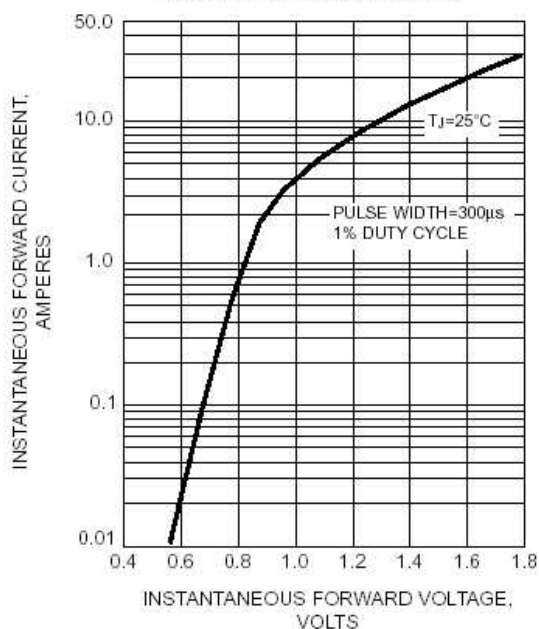


FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

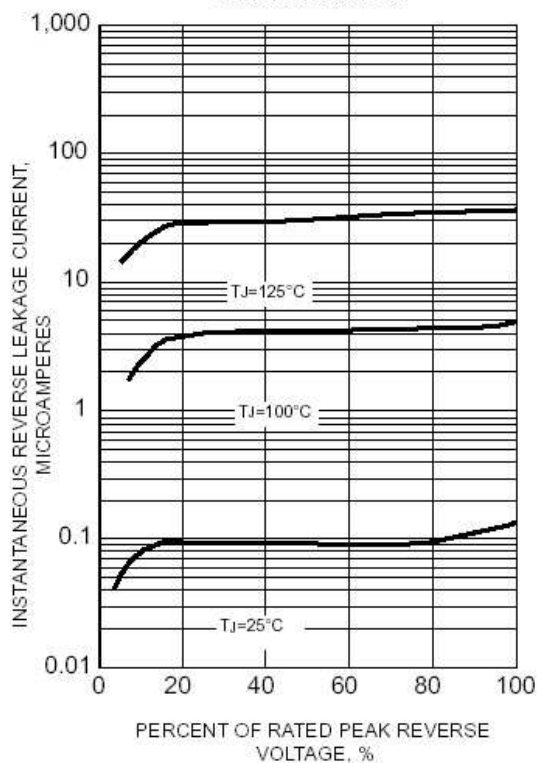


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

